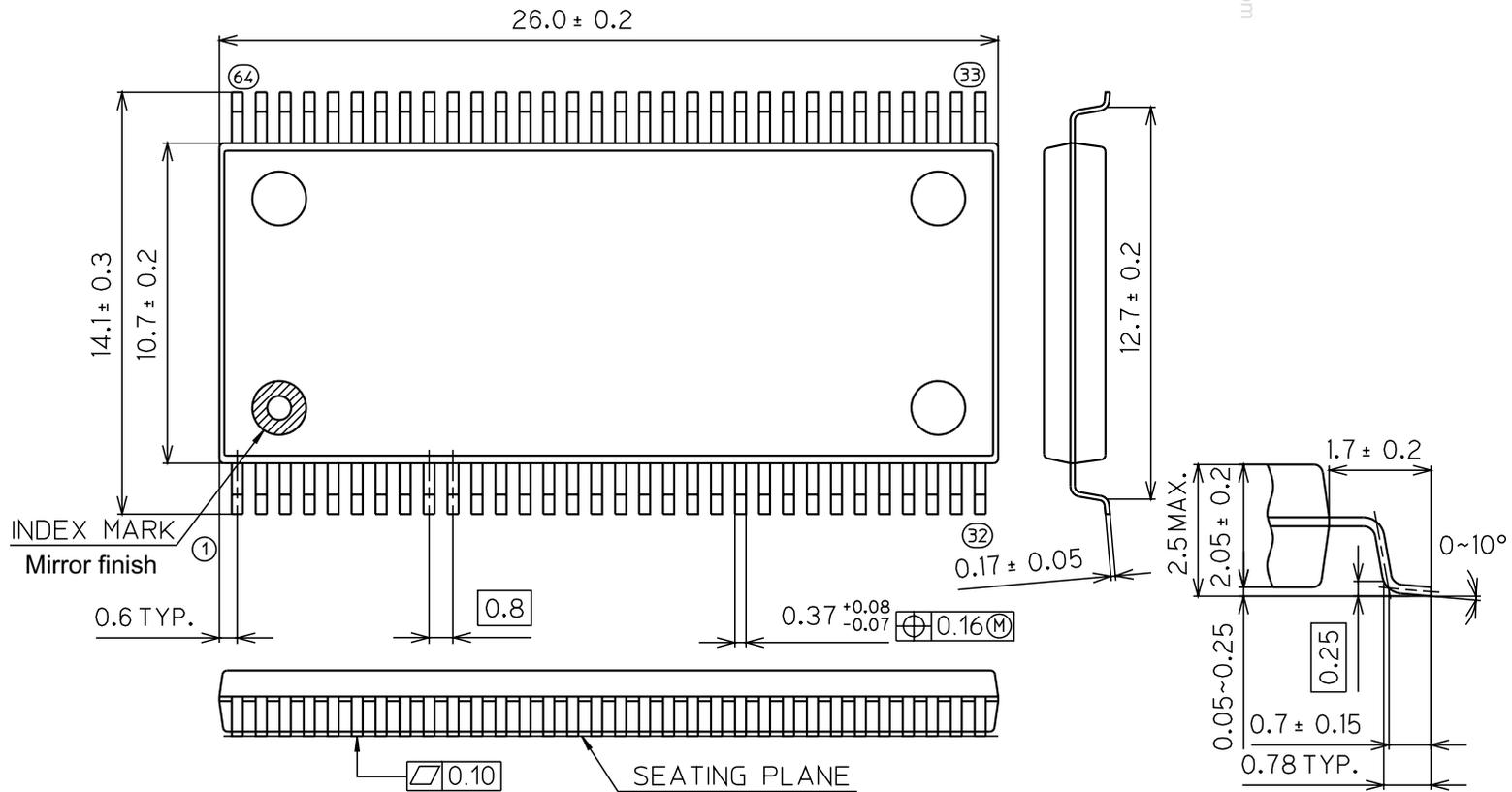


SSOP64-P-525-0.80-K



Package material	Epoxy resin
Lead frame material	42 alloy
Pin treatment	Solder plating ($\geq 5\mu\text{m}$)
Package weight (g)	1.34 TYP.
Rev. No./Last Revised	3/Dec. 5, 1996

Oki Electric Industry Co., Ltd.